Financial Results for the 2nd Quarter of Fiscal Year Ending March 31, 2019

November 2018

MARUBUN CORPORATION

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1H FY3/19 Summary of Consolidated Financial Results

1H FY3/19 Summary of Consolidated Financial Results

Net sales : ¥166.4 billion (-¥3.4 billion YoY)

- Electronic Devices Business Decrease for TV and PC
- Electronic Systems Business Increase in Space and Defense Electronics, Medical Equipment
- Operating income : ¥2.5 billion (+¥0.8billion YoY)

■Gross profit Increase of the reversal in the fiscal year under review of inventory valuation losses of the goods purchased in foreign currency for sale recorded at the end of the previous fiscal year because of the

continuing strong yen.

Ordinary income: ¥0.6 billion (-¥0.7 billion YoY)

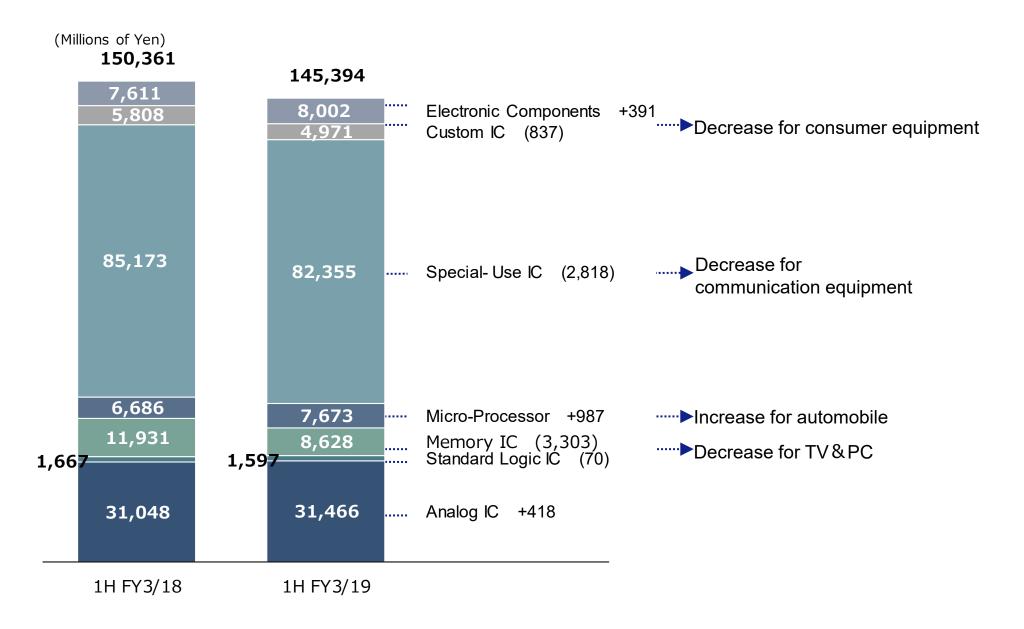
■ Non-operating expenses Foreign exchange losses due to settlement and valuation of debts in foreign currency as a result of the weakening yen from the beginning of the fiscal year under review.

Net income : ¥0.1 billion (-¥0.2 billion YoY)

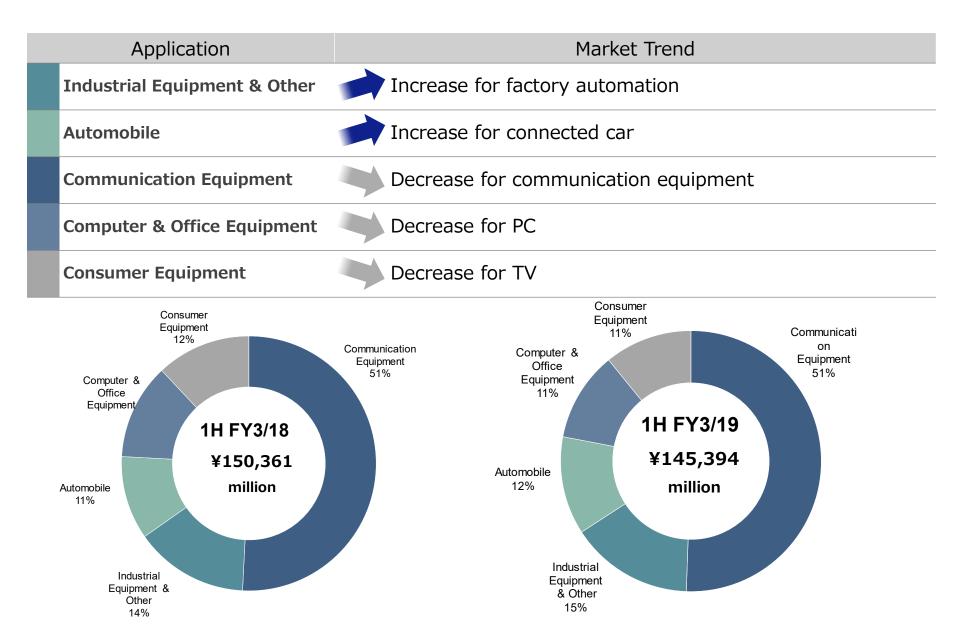
1H FY3/19 Summary of Financial Results

(Millions of Yen)	1H F	FY3/18		1H FY3/19)	YoY C	hanges	Initial
	Actual	Composition Ratio	Initial Forecasts	Actual	Composition Ratio	Amount	%	Forecasts vs Actual
Net sales	169,875	100.0%	160,000	166,434	100.0%	(3,441)	-2.0%	6,434
Electronic Devices	150,361	88.5%	139,000	145,394	87.4%	(4,967)	-3.3%	6,394
Electronic Systems	19,513	11.5%	21,000	21,040	12.6%	1,527	7.8%	40
Gross profit	10,272	6.0%	10,200	11,382	6.8%	1,110	10.8%	1,182
SG&A expenses	8,518	5.0%	8,950	8,807	5.3%	289	3.4%	(143)
Personal expenses	5,159	3.0%	-	5,292	3.2%	133	2.6%	-
Other	3,358	2.0%	-	3,514	2.1%	156	4.6%	-
Operating income	1,753	1.0%	1,250	2,575	1.5%	822	46.9%	1,325
Non-operating income	319	0.2%	250	296	0.2%	(23)	-7.2%	46
Non-operating expenses	757	0.4%	480	2,254	1.4%	1,497	197.8%	1,774
Ordinary income	1,314	0.8%	1,020	617	0.4%	(697)	-53.0%	(403)
Extraordinary income	0	0.0%	0	23	0.0%	23	-	23
Extraordinary loss	211	0.1%	0	17	0.0%	(194)	-91.9%	17
Profit attributable to owners of parent	390	0.2%	465	133	0.1%	(257)	-65.9%	(332)
No. of employees	1,408	-	-	1,350	-	(58)	-4.1%	-

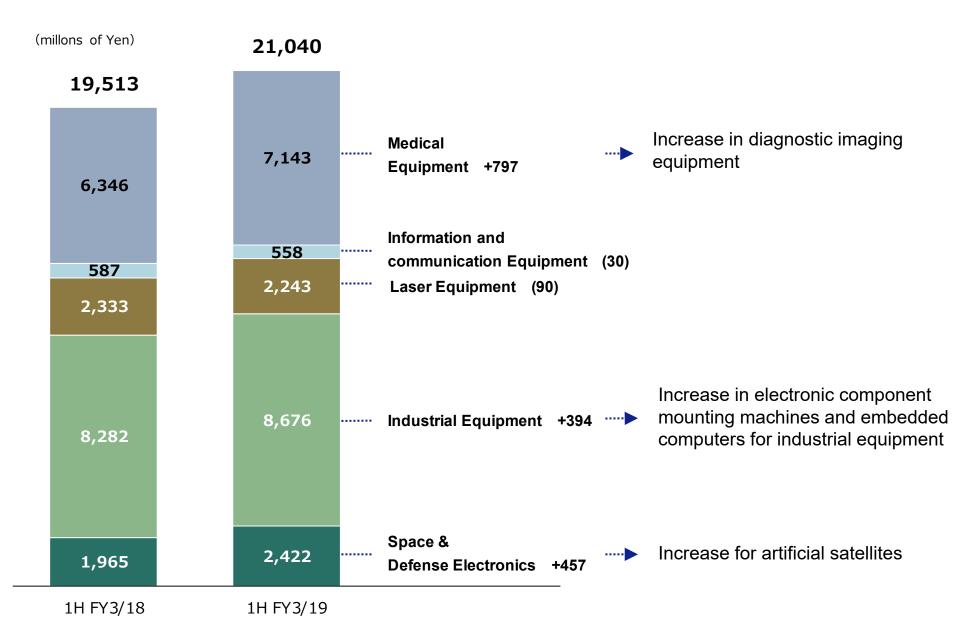
1H FY3/1FY3/19 "Electronic Devices Business" Net Sales Breakdown by Product



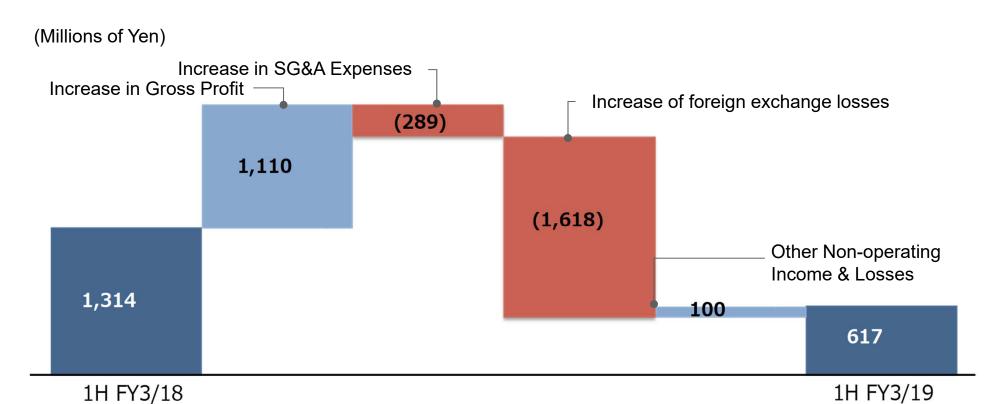
1H FY3/19 "Electronic Devices Business" Market Trend by Application



1H FY3/19 "Electronic Systems Business" Net Sales Breakdown by Product



1H FY3/19 Factors Affecting Ordinary Income



Gross Profit	Increase in gross profit 1H FY3/18: ¥10.2 billion (6.0%) => 1H FY3/19: ¥11.3 billion (6.8%)
SG&A Expenses	Increase of personal expenses and outsourcing fee 1H FY3/18: ¥8.5 billion => 1H FY3/19: ¥8.8 billion
Non-operating Income/Loss	Increase of foreign exchange losses 1H FY3/18: gains of ¥6 million => 1H FY3/19: losses of ¥1.6 billion

1H FY3/19 Summary of Balance Sheets

(Millions of Yen)	FY18/3 Actual	1H FY3/19 Actual	Changes Amount	Reason for change	
Total assets	135,706	137,315	1,609	Notes and accounts receivable-trade	5,354
Current assets	122,297	123,569	1,272	Merchandise and finished goods	(6,943)
Noncurrent assets	13,408	13,746	338		
Total liabilities	86,529	88,669	2,140	Notes and accounts payable-trade	1,886
Current liabilities	75,765	78,220	2,455		
Noncurrent liabilities	10,763	10,448	(315)		
Total net assets	49,177	48,646	(531)		

Medium-Term Vision Business Strategies and Key Initiatives

Management Environment

Movements of industry reorganization

Semiconductor manufacturers

Expansion of M&A

Electronics trading company

Progress of business integration and M&A

Themes of semiconductor industry

AI/Robots/IoT technology

Promotion of usage

Entry by many players

Chaotic situations

Medium-Term Vision (2016-2018)

Medium-Term Vision (FY3/19)

Catching up with industry reorganization

Catching new
businesses
through
active investment

Improving capital efficiency



Realization of sustainable growth

Four initiatives for Electronic Devices



- (1) Expansion of the mainstay business
- (2) Development of businesses in growth markets
- (3) Rapid commercialization of new products
- (4) Enhancement of global operations

(1) Expansion of the Mainstay Business

Promotion of demand creation activities

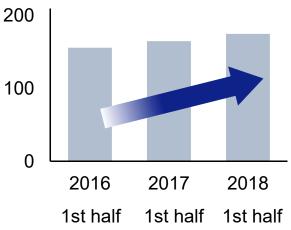
Expansion of sales system for key devices such as analog and wireless

Enhancement of solutions in the automobile market

- Focus on automated driving/EV/hybrid/network
- Alliance with advanced suppliers
 - Start of handling of controller IC for motor control
- Conduct of proposal activities in terms of area, rather than point

Trends in sales to the automotive sector

(hundred million yen)





Silicon Mobility controller IC for motor control

(1) Expansion of the Mainstay Business

- Initiatives for industrial equipment and the mass market
 - Establishment of specialized organization
 - Effective promotion by digital marketing
- Strengthening of business foundation and realization of more efficient business management
 - Integration of KTL Corp. into Marubun Corp.
 - Transfer of the business of Marubun Semicon Corp. to TOMEN DEVICES Corp.

(2) Development of Businesses in Growth Markets

Medical/healthcare

MC10

Bio sensor

 Demonstration experiment for healthcare with various companies, including fitness and wear





IoT

Afero

■ IoT platform

 Promotion of adoption with smart lock, etc.

Cypress

Wireless-related products for IoT

Growing into the mainstay business



(3) Rapid Commercialization of New Products

Launch of new business model different from the conventional sales of semiconductors

FINsix

- Joint development with Toyota Industries Corporation
 - Inverter for automobiles

Steady progress

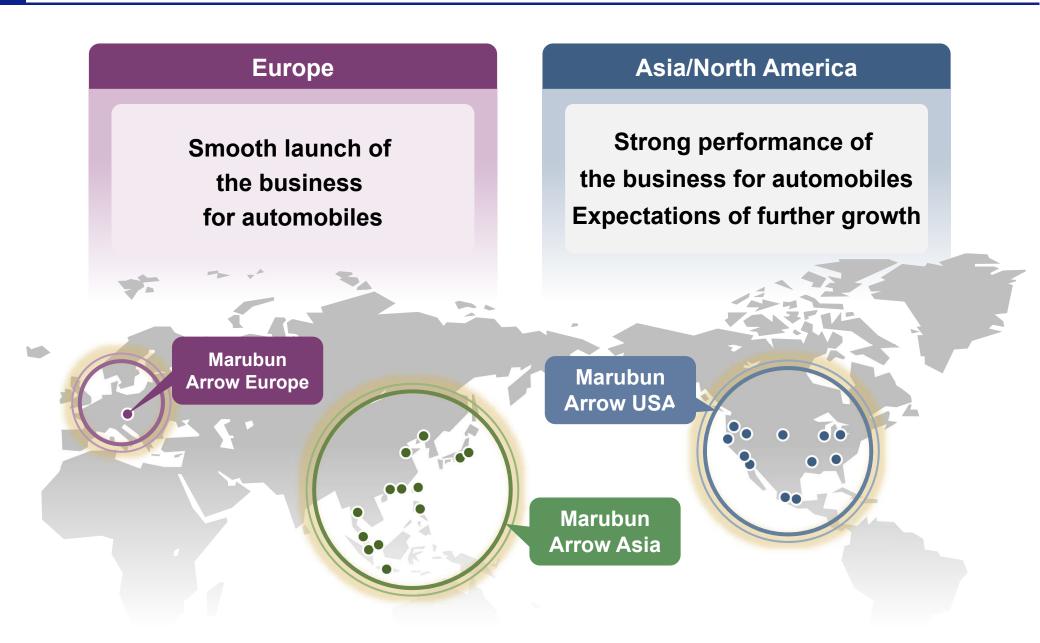


Nanoramic Laboratories

- Handling of nano carbon products
 - High-quality head conductive materials
 - Small capacitor with excellent heat resistance and strength



(4) Enhancement of Global Operations



Initiatives of "Electronic Systems"



Enhancing engineering services
Strengthening system integration capability

Initiatives of "Electronic Systems" by Segment

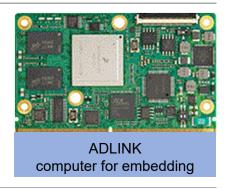
Space and defense electronics

Focus on the capture of highly reliable parts and components for artificial satellites and robots



Industrial equipment

- Focus on sales of inspection equipment and failure analysis equipment for electronic parts for on-vehicle use/smartphones
- Sales expansion of embedded computers for industrial equipment



Laser equipment

Promotion of sales expansion of marking laser for industrial equipment and light source parts for medical equipment



Initiatives of "Electronic Systems" by Segment

Information and Communication Equipment

- Active sales to carriers and communications infrastructure manufacturers ahead of commercialization of 5G mobile communications system
- Start of sales of high-precision GPS receiver of Septentrio for use in automated driving and agricultural machinery



Medical Equipment

- Development of products for advanced medical equipment
- Expansion and improvement of maintenance services by increasing the number of engineers



FY3/19 Summary of Consolidated Financial Forecasts

FY3/19 Summary of Consolidated Financial Forecasts

Net sales : ¥325 billion (- ¥22.5 billion YoY)

■ Electronic Devices Business Decrease for communication equipment,

TV and PC.

■ Electronic Systems Business Increase in laser equipment, space & defense electronics, and Industrial Equipment.

Operating income: ¥5.8 billion (+ ¥2.0 billion YoY)

■ Gross profit

Increase of the reversal in the fiscal year under review of inventory valuation losses of the goods purchased in foreign currency for sale recorded at the end of the previous fiscal year because of the continuing strong yen.

Increase of profit because of weak yen in this half fiscal year.

Ordinary income: ¥3.4 billion (-¥0.7 billion YoY)

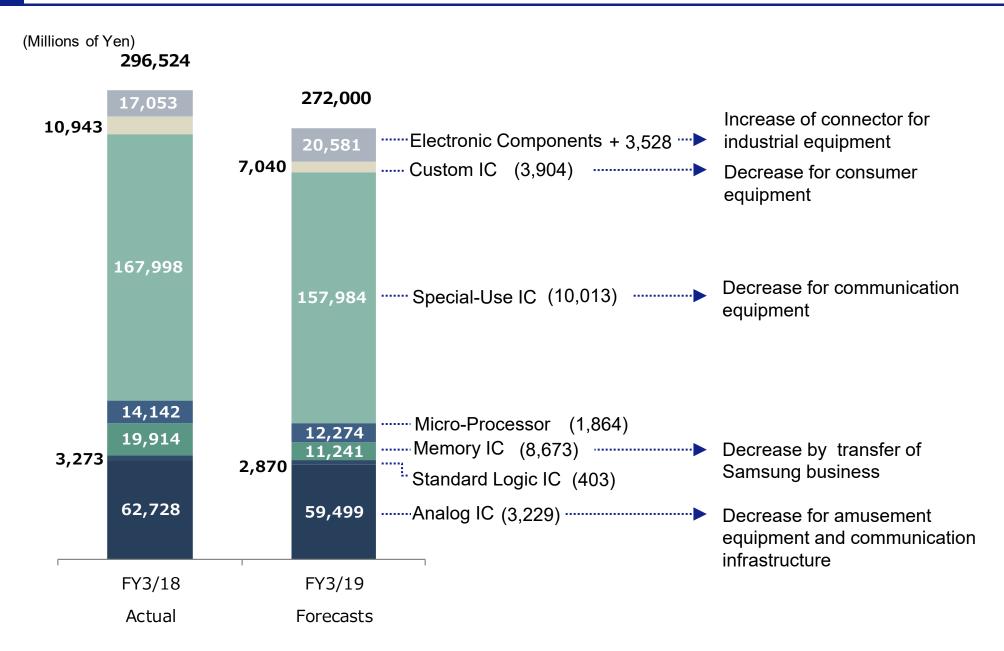
■ Non operating expenses Foreign exchange losses in this half fiscal year.

Net income : ¥1.8 billion (- ¥0.2 billion YoY)

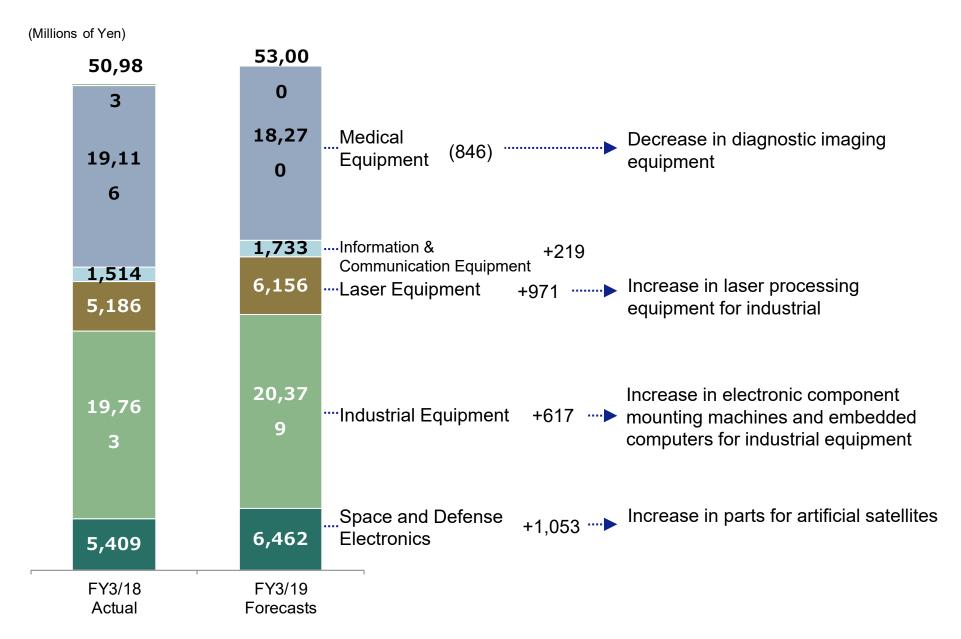
FY3/19 Financial Forecasts

(Millions of Yen)	F	Y3/18		FY3/19	FY3/19 YoY Changes		anges	Initial
	Actual	Composition Ratio	Initial Forecasts	Rivised Forecasts	Compositi on Ratio	Amount	%	Forecasts vs Revised Forecasts
Net sales	347,508	100.0%	315,000	325,000	100.0%	(22,508)	-6.5%	10,000
Electronic Devices	296,524	85.3%	262,500	272,000	83.7%	(24,524)	-8.3%	9,500
Electronic Systems	50,983	14.7%	52,500	53,000	16.3%	2,017	4.0%	500
Gross profit	21,161	6.1%	22,500	23,300	7.2%	2,139	10.1%	800
SG&A expenses	17,390	5.0%	17,800	17,500	5.4%	110	0.6%	(300)
Operating income	3,771	1.1%	4,700	5,800	1.8%	2,029	53.8%	1,100
Non-operating income	1,773	0.5%	550	550	0.2%	(1,223)	-69.0%	0
Non-operating expenses	1,327	0.4%	950	2,900	0.9%	1,573	118.5%	1,950
Ordinary income	4,218	1.2%	4,300	3,450	1.1%	(768)	-18.2%	(850)
Extraordinary income	6	0.0%	-	25	0.0%	19	316.7%	25
Extraordinary loss	311	0.1%	-	25	0.0%	(286)	-92.0%	25
Profit attributable to owners of parent	2,077	0.6%	2,500	1,800	0.6%	(277)	-13.3%	(700)

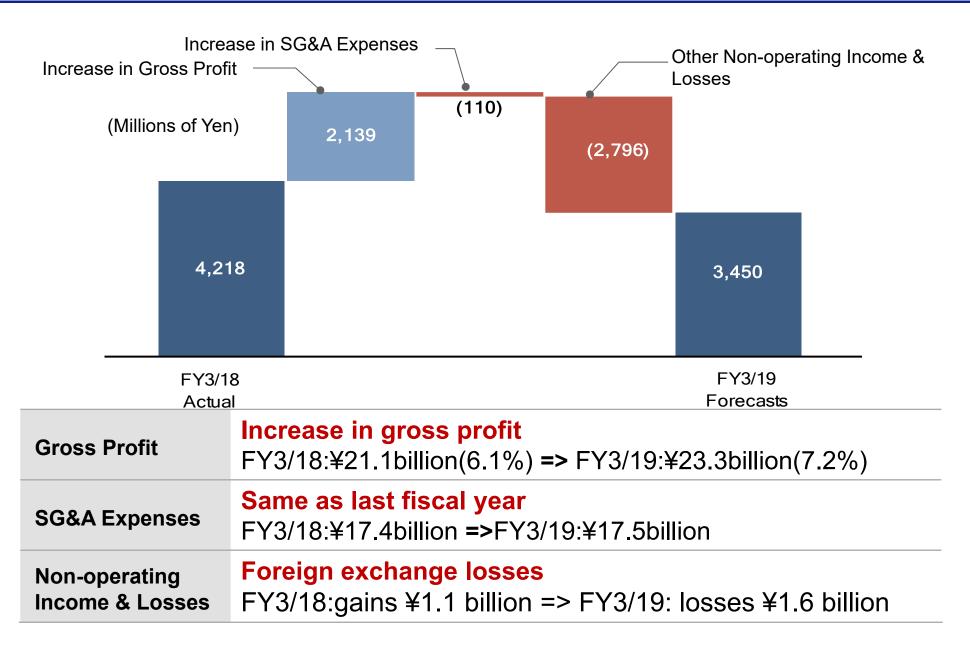
FY3/19 "Electronic Devices Business" Net Sales Forecasts by Product



FY3/19 "Electronic Systems Business" Net Sales Forecasts by Product



FY3/19 Factors Affecting Ordinary Income (last FY vs forecasts)



Return to Shareholders

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Return to Shareholders

Dividend Policy

Dividend Payout Ratio	30% or more (consolidated)
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Dividends Forecast

(Yen)	FY3/18	FY3/19 (Forecast)	
Annual Dividend Per Share	30.00	30.00	
Interim Dividend	10.00	10.00	
Year-End Dividend	20.00 (Year-end dividend 15.00) (Commemorative dividend 5.00)	20.00	

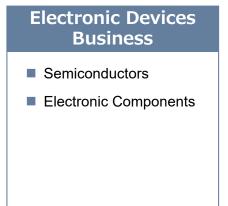
About Marubun

Company Profile

Profile

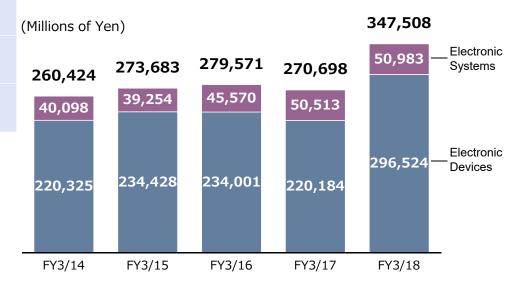
Founded	1844
Incorporated	July 1947
Head Office	8-1, Niihonbashi Odenmacho, Chuo-ku, Tokyo
Capital	¥6,214M
Fiscal Year	Apr.1-Mar.31
CEO	Shoji Mizuno
Revenue	Consolidated: \$3,475M (FY3/18) Non-consolidated: \$2,278M (FY3/18)
Employees	Consolidated: 1,381(end of Mar.2018) Non-consolidated: 670(end of Mar.2018)
Listed	The 1 st Section of the Tokyo Stock Exchange (7537)

Business Domains

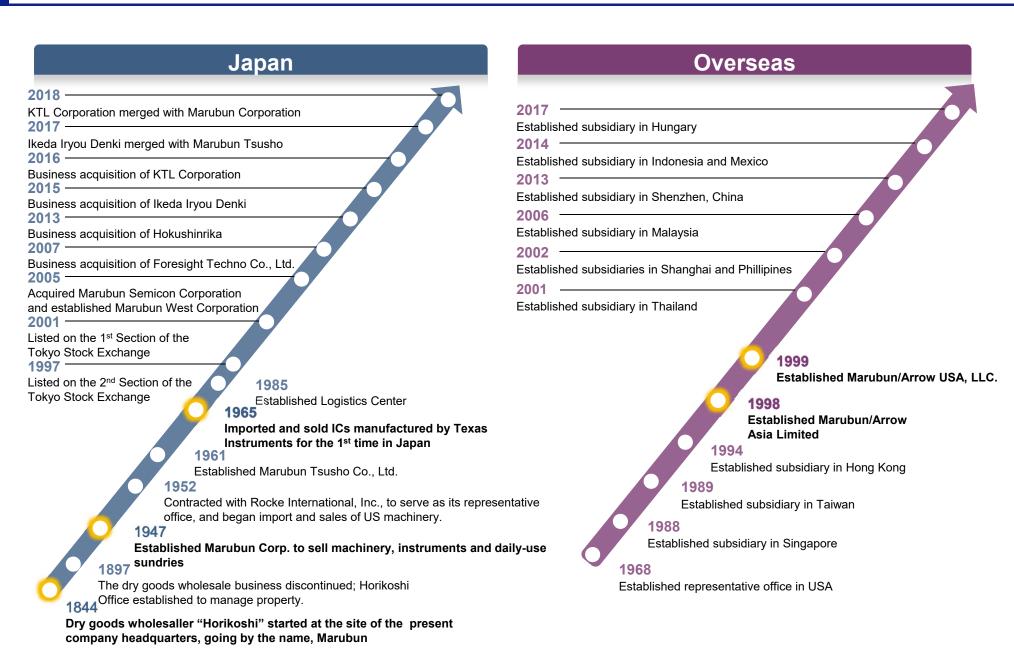




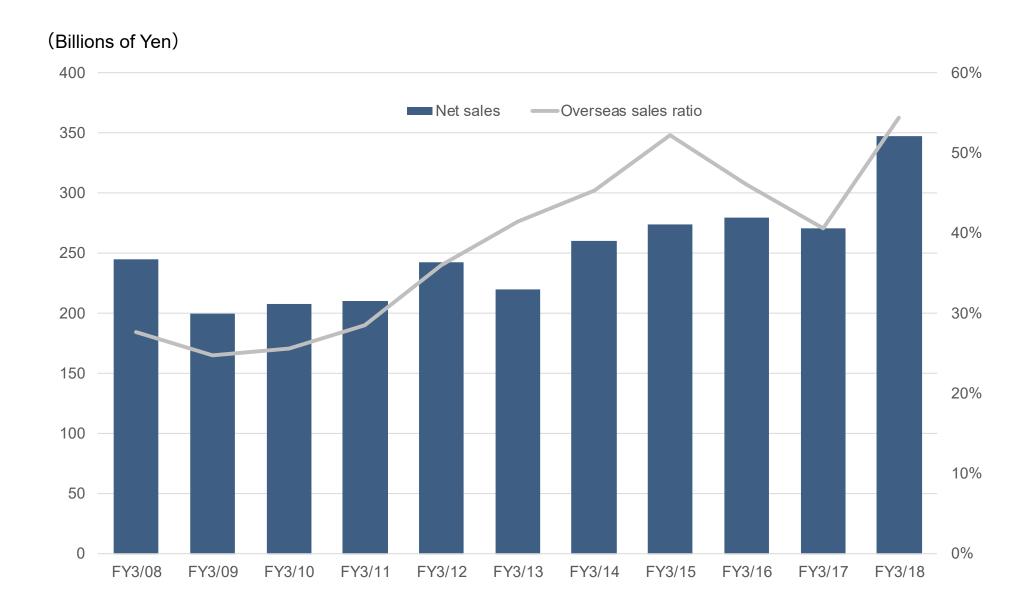
Revenue Trend (Consolidated)



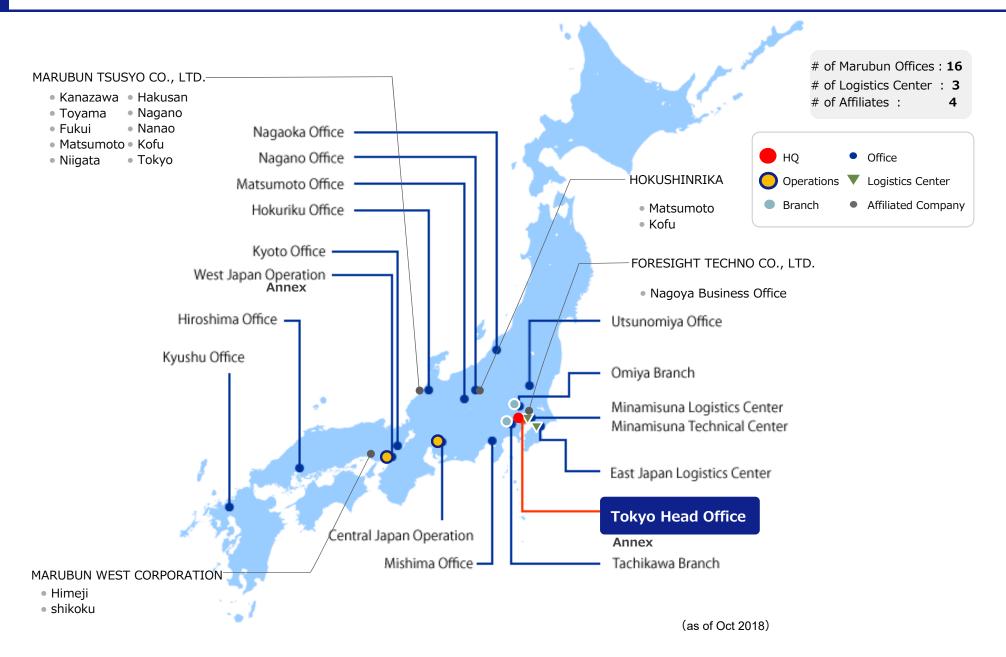
History of Company Operations



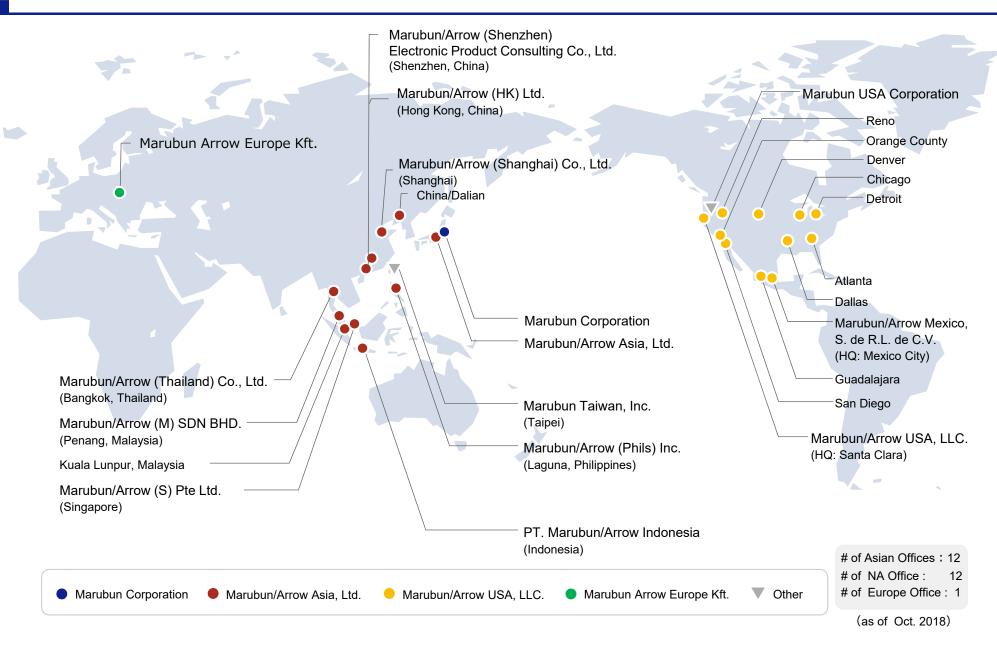
Sales Trend for the Past 10 Years



Domestic Offices

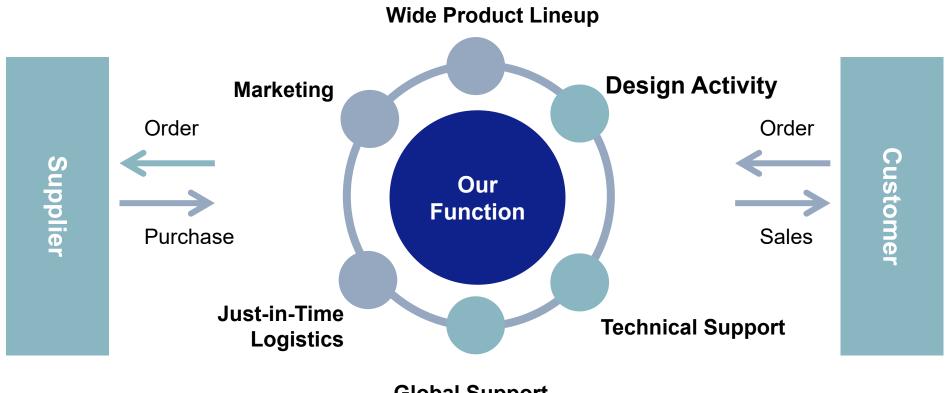


Worldwide Sales Network



Characteristics and Strengths -Electronic Devices-

- Wide Product Lineup through Overseas Suppliers
- Global Sales Network in Alliance with Arrow Electronics, Inc. (80 countries, 345 bases)
- Effective Solution Suggestion through High Technological Skill
- Strong Customer Base



Affiliations -Electronic Devices-

Comnany	Head Quarter	Establish	Share	Business				
Marubun USA Corporation	California, U.S.A.	October 1983	100.0%	Holding company of Marubun/Arrow USA,LLC				
Marubun Taiwan, Inc.	Taipei, Taiwan	November 1989	100.0%	Supply of semiconductors and electronic components made in Taiwan				
Marubun/Arrow Asia, Ltd.	British Virgin Islands	October 1998	50.0%	Holding company of Marubun/Arrow (S) Pte Ltd. and Marubun/Arrow (HK) Ltd.				
Marubun/Arrow (S) Pte Ltd.	Anson Road, Singapore	March 1988	50.0%					
Marubun/Arrow (HK) Ltd.	Hong Kong, China	August 1994	50.0%					
Marubun Arrow (Thailand) Co., Ltd.	Bangkok, Thailand	October 2000	50.0%					
Marubun/Arrow (Phils), Inc.	Laguna, Philippines	October 2001	50.0%					
Marubun Arrow (M) SDN BHD	Penang, Malaysia	June 2006	50.0%					
Marubun/Arrow (Shanghai) Co., Ltd.	Shanghai, China	September 2002	50.0%	Sales of semiconductors and electronic components to Japanese companies in				
Marubun/Arrow (Shenzhen) Electronic Product Consulting Co.,Ltd.	Shenzhen, China	June 2013	50.0%	overseas				
PT. Marubun Arrow Indonesia	Jakarta, Indonesia	April 2014	50.0%					
Marubun/Arrow USA, LLC*	Delaware, U.S.A.	November 1998	50.0%					
Marubun-Arrow Mexico, S. de R.L. de C.V.*	MexicoCity, MEXICO	September 2014	50.0%					
Marubun Arrow Europe Kft.*	Budapest, Hungary	November 2017	50.0%					

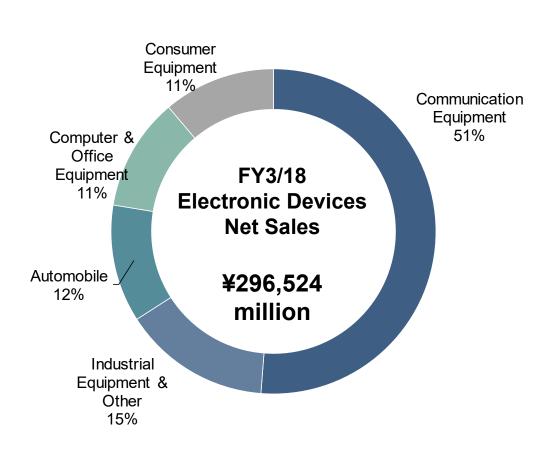
^{*} Marubun/Arrow USA、 Marubun-Arrow Mexico、 Marubun Arrow Europe Kft. are equity method affiliates.

Main Products(by Supplier) -Electronic Devices-

			Supplier														
			ABLIC	Asahikasei Electronics	Broadcom	Cypress	Eink	FINsix	IDT	Littlefuse	Maxim	Molex	Qurvo	Sandisk	Seiko Epson	Texes Instruments	Other
	Analog IC		•	•	•					•	•		•			•	•
	Standard Log	ic IC														•	
		DRAM															•
	Memory IC	Flash Memory												•			•
Sem		Other Memory	•						•					•			
licor	Micro-	MPU、MCU													•	•	•
onpu	processer	DSP		•												•	•
Semiconductors		ASSP		•	•	•			•		•		•		•	•	•
0,	Special-	Display Driver													•	•	
	Use IC	DMD														•	
		LED															•
	Custom IC			•											•		•
Com	Display Devic	ees					•										•
lect	Crystal Devices		•						•						•		
Electronic Components	Connector,Swich,PCB											•					•
c 1ts	Module							•									•

Main Products (by Application) -Electronic Devices-

			Applications							
			Apı	oncatio	ons					
		Communication Equipment	Consumer Equipment	Computer OA	Automobile	Industry Equipment				
Semciondu	ctor									
Analog IC		•								
Standard Log	gic IC	•	•							
MamanulC	DRAM	•								
Memory IC	Flash Memory	•								
Micro-	MPU、MCU	•				•				
processer	DSP	•								
	ASSP	•								
Special-	Display Driver	•								
Use IC	DMD	•			•	•				
	LED	•								
Custam IC		•	•		•					
Electronic C										
Display Devices			•	•	•	•				
Crystal Devices						•				
Connector,S	•	•								
Module										



Characteristics and Strengths -Electronic Systems-

- Providing Technologically Competitive Products in High-End Markets
- Consistent, High-Leve Technical Support (from system integration, installation to maintenance services)

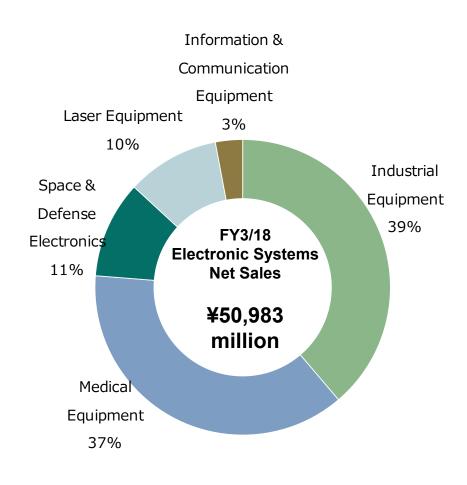


Affiliations -Electronic Systems-

Comnany	Head Quarter	Establish	Share	Business
Marubun Tsusho Co.,Ltd.	Kanazawa City	March 1961	100.0%	Sales of medical equipment and measurement & inspection equipment
Marubun West Corporation	Kobe City	May 2005	100.0%	Sales of measurement & inspection equipment
Hokushinrika Co., Ltd.	Nagano City	November 1951	100.0%	Sales of measurement & inspection equipment
Foresight Techno Co.,Ltd.	Koto-ku Tokyo	March 1999	51.0%	High-Leve Technical Support (system integration, installation to maintenance services)

Main Products - Electronic Systems - 1

		Products	Supplier				
Industria	al	Electronic Components Inspection Equipment	Akim,Unihite System, Seiko Epson,FEI,Shimadzu				
Equipme	ent	Embedded computer system	ARTESYN,Aitech,ADLINK, LayTec, Riber				
Medical		Diagnostic Imaging Equipment	Siemens,Shimazu, Konica Minolta				
Equipme	ent	Hemo Dialysis Equipment	NIKKISO,Asahi Kasei Medical, Kaneka Medix				
Laser		Laser Diode,Laser Processor	nLight,Laserline				
Equipme	ent	Network Solutions,Optical Components	Excelitas Technologies, Luminus Drvices, First Sensor				
Space &		High-reliability Components, Measurement and Sensor Equipment	Tele Communication Systems, GE Sensing, Meggit, Plascore				
Electron		Avionics Test System & Simulator Equipment, Microwave Equipment	TEXTRON, L3 Technologies,CPI,Bird				
Informai Commu n Eqipm	nicatio	RF · Optical communication	PCTEL,Finisar,EXFO, Microsemi,Calnex,Spirent				



Main Products -Electronic Systems- 2

Space & Defense Electronics



BEI Sensors High-reliability Components



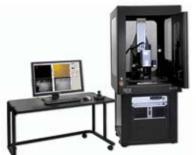
CPI Microwave Equipment

Measurement & Inspection Equipment



Shimazu Gas Chromatography





FEI Infrared Inspection Equipment



Akim
Electronic Components
Inspection Equipment



FUJI Ultra High Density Atmospheric Pressure Plasma Device

Main Products - Electronic Systems - 3

Laser Equipment



nLIGHT Laser Diode



Laserline
Laser Processor

Informaiton & Communication



Microsemi Network Timeserver



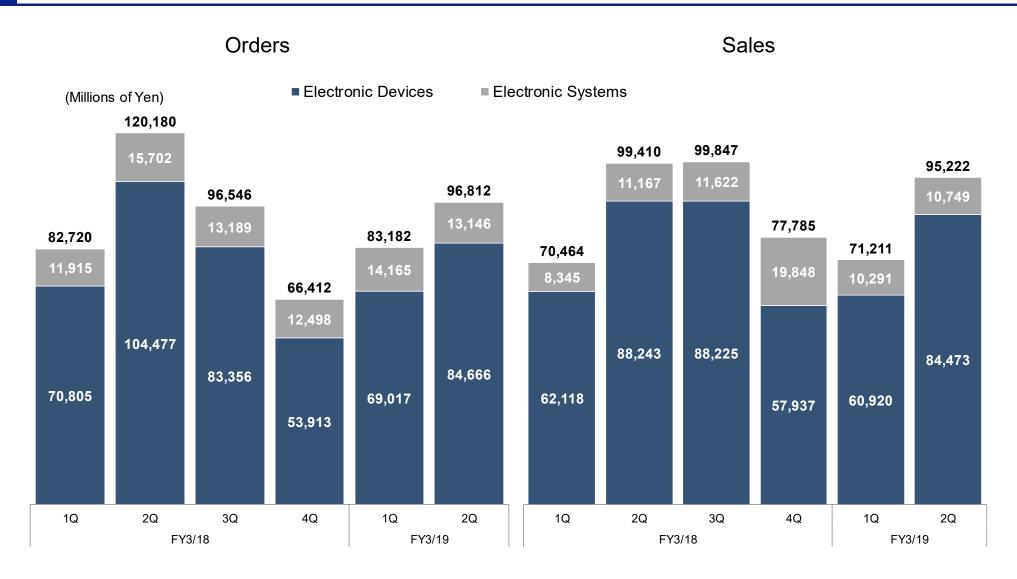
Spirent GNSS Simulator

Medical Equipment

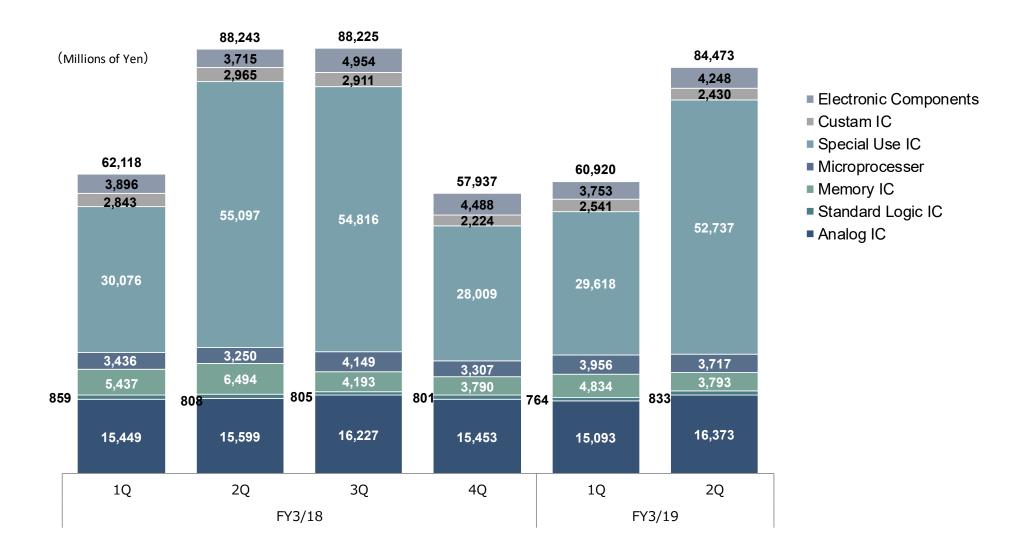


Siemens Japan Diagnostic Imaging Equipment

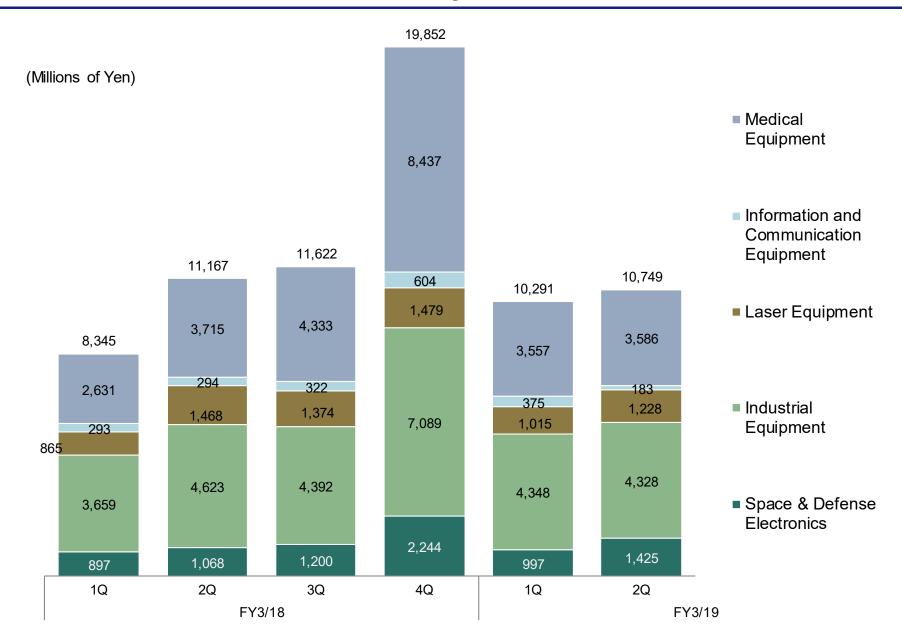
Quarterly Trend in Orders/Sales by Business



Quarterly Trend in Sales of Electronic Devices by Product



Trend in Sales of Electronic Systems



Cautionary Statement

Information on future performance contained within this presentation material, such as the results forecasts, is based on the data available and assumptions judged to be reasonable as of when the Company prepared this presentation material.

Contact

MARUBUN CORPORATION

CORPORATE PLANNING Dept.

PHONE +81-3-3639-3010

E-mail ir@marubun.co.jp